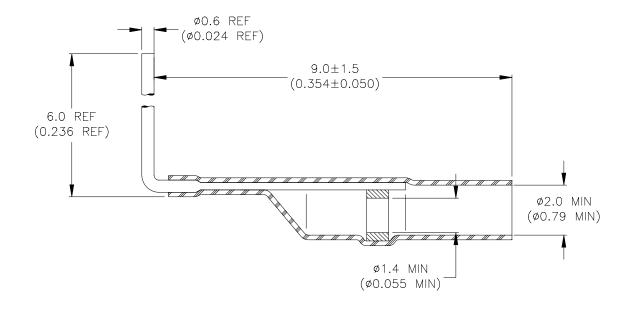
## SPECIFICATION CONTROL DRAWING



## **MATERIALS**

- 1. INSULATION SLEEVE: Heat shrinkable, transparent blue, radiation cross-linked modified polyvinylidene fluoride.
- 2. SOLDER PREFORM WITH FLUX:

SOLDER: TYPE Sn63 per ANSI J-STD-006.

FLUX: TYPE ROL1 per ANSI J-STD-004.

3. PIN: Phosphor bronze coated with Sn60 solder alloy.

## **APPLICATION**

- 1. This controlled soldering device facilitates the strain-relieved termination of stranded wires to printed circuit boards with 0.8mm diameter holes.
- 2. It will terminate the tin-plated or silver-plated copper conductor of a wire whose insulation is rated at 125°C or higher. It will handle 26, 24, and 22 AWG stranded wires.
- 3. For all wires, the strip length shall be  $4.0\pm0.5$  (0.157 $\pm0.020$ )
- 4. The recommended application tool is the AA 400 with Soldersleeve reflector. After the PinPak device is applied to the wire, the pin is cut to the desired length and hand or wave soldered to the board.

	n Interest type ELECTR Constitution Dark, CA 9402	Drive	oct THE	ERMOFIT EVICES	TTLE: PCB TERMINATION PINPAK DEVICE			
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN MILLIMETERS. INCHES DIMENSIONS ARE BETWEEN BRACKETS.					DOCUMENT NO.: <b>B-801-36</b>			
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A	ROUGHNESS IN drawi		sychem reserves the right to amend this awing at any time. Users should evaluate e suitability of the product for their plication.		DCR NUMBER: D001305		REPLACES: N/A	
DRAWN BY: DRAWN		DATE: 0	)5-Dec-00	PROD. REV. E	DOC ISSUE:	SCALE: None	SIZE:	SHEET: 1 of 1

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